

MeiG Smart Technology Co., Ltd

A Global Leading Supplier of Cellular Modules and Solutions

5G 

The text '5G' is in a large, bold, red font. To its right is a red signal icon consisting of three curved lines of increasing size, representing a 5G signal.

To be the Pioneer

About MEIG



Global Market Layout
20+ carriers cooperation
3000+ customers
Global sales service

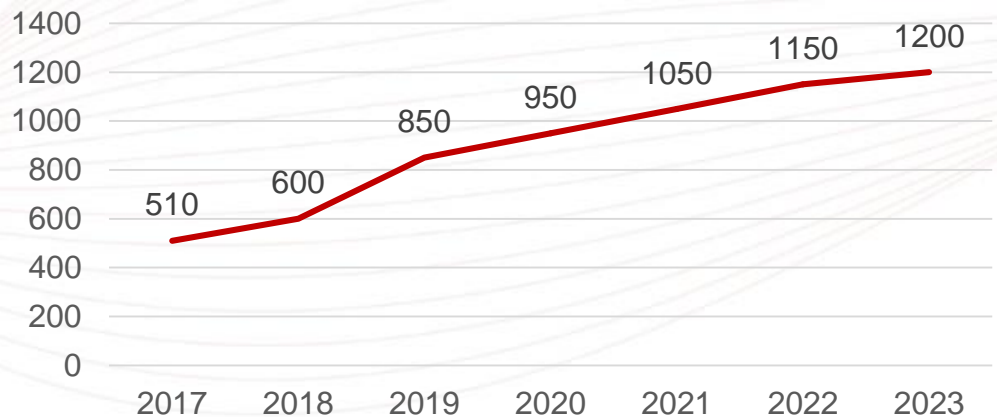
Developing Momentum
50% IoT business growth
30% Team growth rate
20% R&D investment

R&D Driven
800+R&D teams
200+patents
5G sub-6G&mmWave
5G SoC solutions

Delivery
3KK/month SMT
1KK/month Assembly
2 Domestic EMS Factories
1 Overseas EMS Factory



MeiG Team



- Listed on Shenzhen Stock Exchange (SZ: 002881)
- 2 R&D Center and foreign branch companies
- 5G IOT Module Mass Production
- Global Cooperation with Tier1 customers as AT&T, Inseego, TIM, Tracfone, Xiaomi, Telefonica, Orange
- Focus on FWA, IoT and Auto market

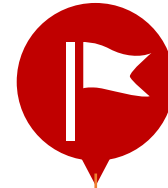
History & Milestone



- Certified by ISO 9001 & ISO14001
- Signed LTE License with Qualcomm

- Huawei vehicle modules
- Xi'an Research Center founded
- Smart Module MP-SLM753, SLM755
- Shareholding reform & IPO formal application

- IoT R&D staff over 900
- Over 1000 customers
- SLM755L, SLM756, SLM757, SLM758 pass AT&T certification
- Cooperate with KDDI, Lime, T-Mobile, Tracfone, AT&T
- Pass IATF16949 certification in 2019
- Signed 5G License with Qualcomm



● Take Root 2009-2011

● Progress 2014-2015

● Move Forward 2018-2019

2007-2008

● Start

- Foundation in Shenzhen
- Shanghai R&D center was founded



2012-2013

● Develop

- National Hi-tech Enterprise
- Softbank & CMCC supplier for MiFi & Dongle
- LTE M2M Module MP-SLM730, SLM750



2016-2017

● Leading

- Stocks listed on Shenzhen Stock Exchange-002881
- 100+ industry customers
- Cooperate with Continental, DoCoMo, Honeywell
- Smart Module MP-SLM755L, SLM756, SLM757, SLM758
- Automotive Module: MA800
- NB-IoT Module: SLM151



2020~2023...

● Better Future

- 5G mmWave FWA products delivered to American operators
- 3000+ module customers
- 5G smart module applied in intelligent cockpit MP
- Successful Tenderer for China Unicom Cat1 & 5G projects
- MeiG Smart Manufacturing & Reliability Testing Center
- 5G Auto Smart Module MP in BYD



Business Development Planning



Revenue \$312Million

Revenue \$340 Million

Revenue \$420 Million

IoT module



M2M Module

- 4G : 25%
- 5G : 9%

Smart Module

- 4G : 54%
- 5G : 11%

Accounts for 35%
(Auto: 42%)



M2M Module

- 4G: 18%
- 5G: 17%

Smart Module

- 4G: 35%
- 5G: 30%

Accounts for 42%
(Auto: 66%)



M2M Module

- 4G: 17%
- 5G: 23%

Smart Module

- 4G: 27%
- 5G: 30%

Module with high computing power

- 3%

Accounts for 43%
(Auto: 70%)

FWA



IDU & ODU

- 4G: 40%
- 5G: 20%

MIFI & Dongle

- 4G: 29%
- 5G: 11%

Accounts for 35%



IDU & ODU

- 4G: 32%
- 5G: 28%

MIFI & Dongle

- 4G: 18%
- 5G: 22%

Accounts for 35%



IDU & ODU

- 4G: 24%
- 5G: 42%

MIFI

- 4G: 14%
- 5G: 20%

Accounts for 35%

Customized Service



PCBA

- 4G: 73%
- 5G: 27%

Accounts for 30%



ODM

- 4G: 25%
- 5G: 15%

PCBA

- 4G: 30%
- 5G: 30%

Accounts for 23%



ODM

- 5G: 24%
- 4G: 17%

PCBA

- 5G: 18%
- 4G: 43%

Accounts for 22%

Business Goal in 5 Years:

- Core business: 30% YoY growth, reaching \$1.5 billion revenue in 2026.
- Overseas business: exceed 50%
- Auto business: reach 30%

Advance with partners

2021

2022

2023

2026

R&D Capability



R&D Team

- Over **800** R&D personnel
- **90%** have bachelor degree or above
- **59%** have 5+ years working experience
- Team growth rate reached **30%**
Expected to attain 1,500 employees in 2023

R&D Labs

- **>\$14M Investment**
- **5 x** Shielding Rooms
- **8000** square meters for testing labs
- Simulation **100+** network environment
- Simulation production line and test

Reliability Labs

- Environment & ORT
- Component reliability
- Waterproof and dustproof
- Failure analysis
- Static Protection
- Environmental verification



5G Capability

- **5G Antenna Design & Test**
- **Thermal Simulation & Design**
- **5G NR Sub6 Physical & Application Layer Performance Test**

5G Test Instruments

- **KeySight** Sub6G & mmW Test Equipment
- **Anritsu** Sub6G & mmW Test Equipment



Certification





CE



FCC



PTCRB



CTA



JATE



IC



AT&T



TMO



Verizon



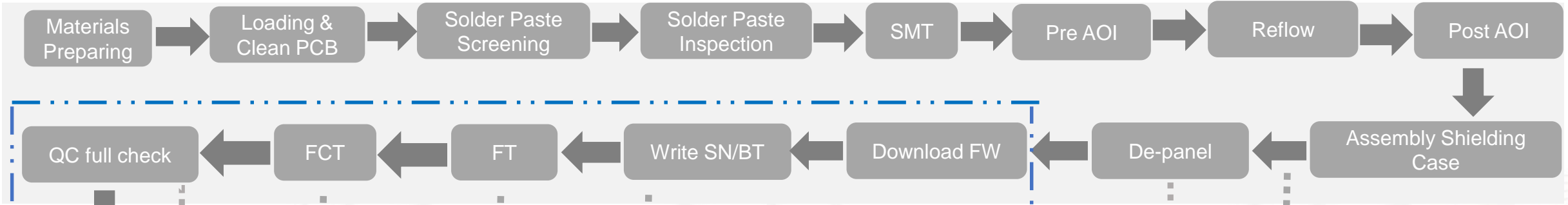
- More than 200 products have been delivered to 80% region of the world
- Rich experience in certification and carriers' technical approval tests of IoT products
- GCF/CE/FCC/PTCRB/CCC/CTA/SRRC/Jate/Telec/RCM/EAC/WEEE&RoHS;
- AT&T/Verizon/TMO/Tracfone/VDF/Orange/KDDI/Docomo/Telefonica/Telcel/TIM/MTN;



Quality Control



IPQC Check FAI, Check the component Type, Polarity, etc.by BOM &Layout



IPQC Sample Inspection

Sample Inspection Quality with X-ray Machine

Check Appearance Quality with MES



- MeiG self-developed MES system
- Highly matched product characteristics



- Systematic Interception

Manufacturing

Shuoge HZ China



MeiG self-owned factory

Shuoge is an intelligent factory owned by MeiG, covering an area of 14,000 square meters. It is constructed for 5G automotive modules, 5G customization, standard modules, etc. The production line is highly automated and has industrial-leading equipment, which can guarantee a module capacity of 5KK/ month and complete unit assembly capacity of 1KK/ month.

BYD SZ China



Partnership with BYD

Founded in February 1995, BYD has set up more than 30 industrial parks around the world. As a leading global electronics manufacturing service enterprise, it produces products such as mobile phone, PAD, laptop, automotive electronics, etc. Its customers include Huawei, Lenovo, Telit, DJI, Amazon and other well-known enterprises at home and abroad.

Meiko Vietnam



Partnership with Meiko

Meiko is a well-known Japanese PCB manufacturing enterprise. In 2008, Vietnam Meiko started EMS manufacturing service business, operating car products, HDD and mobile phones. Its main customers are Stanley, Vinfast, Hitachi and other well-known enterprises.

Meiko Japan



Partnership with Meiko

Meiko Embedded established in 2001 under the NEC Group, which is an ODM development and manufacturing manufacturer that joined the Meiko Group in 2022. We are developing various applications such as in-vehicle products such as DMS, communication terminals, and printers.

Capacity: SMT 3kk/ Month, Assembly 1kk/Month

➤ 5G module 99.2% yield, Cat1 module 99.5% yield, 100% automation rate

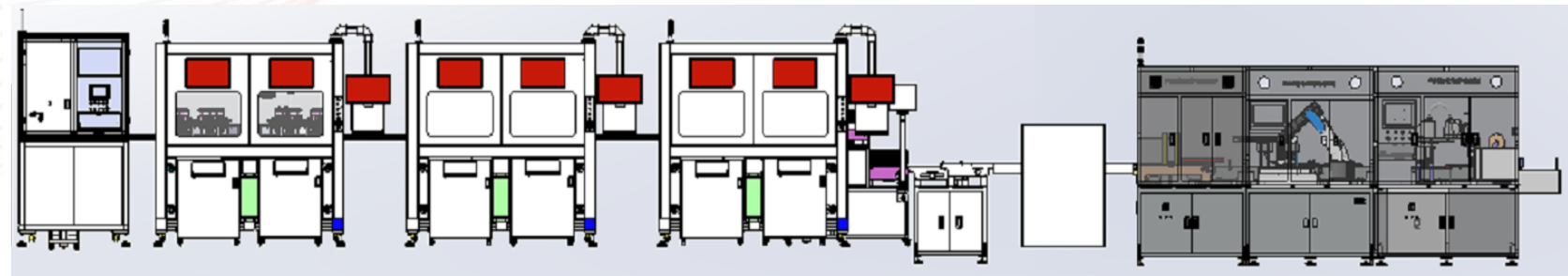
Automated Manufacturing for Module

SMT Whole Line Diagram



ERSA Selective Machine

Automated Test Line (Standard Module & PCB Apply)




MBB Chip Roadmap

- Launched
- Developing
- Planning

5G

4G



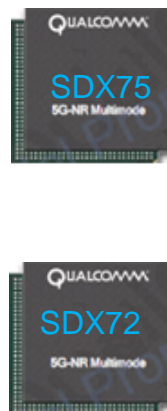
SDX55

- 3GPP Rel 15
- SA and NSA Sub-6
- NSA mmWave
- Sub-6GHz 5G FDD and TDD
- 4G: 20-layer DL/ 2CA UL



SDX65/62

- 3GPP Rel 16 Up to 10Gbps
- mmWave: 800MHz
- Sub6:300MHz,4CC CA
- 8RX and PC1.5 Support
- 4G: 20-layer DL/2CA UL
- Cost: High
- 3GPP Rel 16 Up to 4.4Gbps
- mmWave: 400MHz
- Sub6: 120MHz, 2CC CA
- PC1.5 Support
- 4G:16-layer DL/2CA UL
- Cost: Low



SDX75/72

- 3GPP Rel 17 modem
- Sub6G & mmWave SA/NSA




9X50

- 3GPP Rel 11
- LTE Cat 16 (DL)/Cat 13 (UL) multi-mode



V510

- 3GPP Rel 15
- NR NSA(EN-DC) and SA
- NR DL/ UL : 2Gbps/ 1Gbps




SDX35

- 3GPP Rel 17 Redcap modem
- sub6G SA



9X07

- Cortex-A7, up to 1.2 GHz
- 3GPP Rel 9 LTE Cat 4




X12

- 3GPP Rel 12
- LTE Cat 12 (DL)/Cat 13 (UL) multi-mode




8520

- 3GPP Rel 16
- Sub-6G/Sub-7GHz
- NR 100MHz+100MHz
- NRLLC
- LTE Cat19




1826/1828

- ARM Cortex-A7
- LTE Cat 7 multi-mode



1803

- ARM Cortex-A7
- LTE Cat 4 multi-mode



83XX

- 3GPP Rel 17 Redcap
- Linux&RTOS
- PCIe,ETH,USB
- -40°C~85°C





M2M Module



5G

LTE-A

LTE

Cat1

NB/CatM

	SRM815 M.2 <ul style="list-style-type: none"> X55 5G NR Sub6 M.2 56*43*3.65mm 	SRM815-GL <ul style="list-style-type: none"> X55 5G NR SA&NSA LGA 44*43*2.8mm 	SRM825W <ul style="list-style-type: none"> X55 5G NR Sub6 & mmWave M.2 30*52*3.6mm 	2022Q2 SRM825WN <ul style="list-style-type: none"> X62 5G NR Sub6 & mmWave M.2 30*52*2.3mm 	2022Q3 SRM815N <ul style="list-style-type: none"> X62 5G NR SA&NSA LGA 44*43*2.75mm
SRM815 <ul style="list-style-type: none"> X55 5G NR Sub6 LGA 44*41*2.8mm 	SRM815 MiniPCIE <ul style="list-style-type: none"> X55 5G NR Sub6 Mini PCIE 51*49*5.4mm 	SRM825L <ul style="list-style-type: none"> Qualcomm 315 5G NR SA M.2 30*52*3.6mm 	SRM811 <ul style="list-style-type: none"> Unisoc V510 5G NR SA&NSA LGA 44*41*2.8mm 	2022Q2 SRM821 <ul style="list-style-type: none"> Unisoc V510 5G NR SA&NSA M.2 30*52*2.3mm 	2022Q4 SRM827W <ul style="list-style-type: none"> X65 5G NR Sub6 & mmWave M.2 30*52*2.3mm
	SLM820 <ul style="list-style-type: none"> MDM9x50 LTE Cat6/12/16 M.2 30*42*2.3mm 	SLM828 <ul style="list-style-type: none"> SDX12 LTE Cat6 Mini PCIE 51*30*4.5mm 	SLM828-G <ul style="list-style-type: none"> SDX12 LTE Cat6/12 LGA 39.5*37*3mm 		2022Q3 SLM828-M <ul style="list-style-type: none"> SDX12 LTE Cat6/12 M.2 30*42*2.3mm
SLM750-VX <ul style="list-style-type: none"> MDM9X07 LTE Cat4 LCC 32*29*2.8mm 	MA800 <ul style="list-style-type: none"> MDM9628 LTE Cat4 LGA 37.5*33*3.0mm 	SLM790 <ul style="list-style-type: none"> Hisi V711 LTE Cat4 LCC 29*32*2.8mm 		2022Q2 SLM750-G <ul style="list-style-type: none"> MDM9X07 LTE Cat4 LCC 32*29*2.8mm 	
SLM730 <ul style="list-style-type: none"> MDM9X07 LTE Cat4 Mini-PCle 51*30*4.5mm 	SLM750-ZX <ul style="list-style-type: none"> MDM9X07 LTE Cat1 LCC 32*29*2.8mm 	SLM750-ZX Mini PCIE <ul style="list-style-type: none"> MDM9X07 LTE Cat1/CAT4 PCIE 51.0*30.0*4.8mm 		2022Q2 SLM770U <ul style="list-style-type: none"> Unisoc 8310 LTE Cat4 LCC+LGA 32*29mm 	2022Q2 SLM770A <ul style="list-style-type: none"> ASR1803 LTE Cat4 LCC+LGA 32*29mm
SLM320 <ul style="list-style-type: none"> 8910DM LTE Cat1 LCC+LGA 32*29*2.6mm 	SLM330 <ul style="list-style-type: none"> 8910DM LTE Cat1 LCC+LGA 29*25*2.4mm 	SLM328 <ul style="list-style-type: none"> 8910DM LTE Cat1 LCC+LGA 19.6*21.8mm 	SLM322 <ul style="list-style-type: none"> 8910DM LTE Cat1 LCC 23.9*22.9mm 	SLM326 <ul style="list-style-type: none"> 8910DM LTE Cat1 LCC+LGA 27.6*25.4mm 	2022Q1 SLM332 <ul style="list-style-type: none"> Unisoc 8850 LTE Cat1 LCC 15.7*17.6mm
SLM156 <ul style="list-style-type: none"> MDM9205 NB-IoT/CatM/GPRS LCC 17.6*15.9*2.3mm 	SLM130 <ul style="list-style-type: none"> EC616/QC212 NB-IoT LCC 17.6*15.9*2.3mm 	SLM160 <ul style="list-style-type: none"> EC616 NB-IoT LCC 18*16mm 	SLM190 <ul style="list-style-type: none"> EC616 NB-IoT LCC+LGA 23.6*19.9mm 	SLM100 <ul style="list-style-type: none"> EC616 NB-IoT LGA 10.0*10.0mm 	

Before 2020

2021

2022

Android SoC Roadmap



5G

High

Middle

Low



2*A77 2.0Ghz +6*A55 1.8Ghz
8nm
2* HVX512
Dual Display



1*2.7GHz + 3*2.4GHz
+ 4*1.9GHz
6nm
11 Tops AI
2*PCleDual Display
2*USB



2*2.1GHz A78
+ 4*1.8GHz A55
6nm
3.5 Tops AI
2*PCleDual Display
2*USB



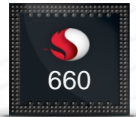
1*3.2GHz + 3*2.75GHz
+ 4*2.0GHz
4nm
~27 Tops
5G-NR, R16
GPS L1+L5
WIFI 6E



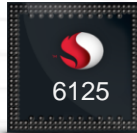
4 + 4 Kryo™ 585
7nm
Triple Display(5040x2160 @60Hz)
6 x CSI-4lane
2 USB 3.1



2*2.4Ghz + 6*A55
4nm
Sub6G+WiFi6E
BT5.2



4*A73 2.2Ghz +4*A53 1.8Ghz
14nm
Triple Display
Adreno512 650Mhz



4*A73 2.0Ghz + 4*A53 1.8Ghz
11nm
Adreno 610
2 x HVX@1Ghz
Dual Display



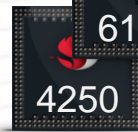
2*A76 2.2Ghz +6*A55 1.9Ghz
Android 12/13/14
De/En 1080p 60fps

SDM450
14nm FF
12x14mm

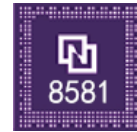
SDM625
8953
14nm FF
12x14mm

8*A53 2.0Ghz
14nm

8*A53 1.8Ghz
14nm



4*A73 2.0Ghz + 4*A53 1.8Ghz
11nm
Adreno 610
2 x HVX@1Ghz



8*A53 1.6Ghz
28nm
Android 10/11



4*A73 2.2Ghz + 4*A53 1.8Ghz
6nm
Adreno 610
Android13



4*A53 1.3Ghz
28nm
Adreno308



4*A53 1.4Ghz
28nm
Android 10/11



4*A53 2.0Ghz
11nm
Android12

Planning

Developing

MP

2021

2022

2023

Smart Module



5G

High

Mid

Entry



2021 SLM900

- SDM660
- 8-Cores 2.2Ghz
- 45.5mm*41mm
- WIFI 2.4G/5G

2021 SLM920

- QCM6125
- 8-Cores 2.0Ghz
- 45.5mm*41mm
- WIFI 2.4G/5G

2021 SRM900

- SM6350
- SUB6G+SA/NSA
- 8-Cores 2.0Ghz
- L1+L5 GPS
- WIFI6 ready

2022 SRM930

- QCM6490
- SUB6G+SA/NSA
- 8-Cores 2.7Ghz
- L1+L5 GPS
- WIFI6

2022 SNM951

- QCS8250
- 8-Cores 2.84Ghz
- WIFI 6
- 15 Tops AI

2021 SLM758L

- SDM450
- 8-Cores 1.8Ghz
- 45.5mm*41mm
- WIFI 2.4G/5G

2021 SLM758N

- MSM8953
- 8-Cores 2.0Ghz
- 45.5mm*41mm
- WIFI 2.4G/5G

2021 SLM500L

- SDM450
- 8-Cores 1.8Ghz
- 40.5mm*40.5mm
- WIFI 2.4G/5G

2021 SLM921

- QCM6125
- 8-Cores 2.0Ghz
- 44mm*43mm
- WIFI 2.4G/5G

2021 SRM910

- SM6350
- SUB6G+SA/NSA
- 8-Cores 2.0Ghz
- L1+L5 GPS
- WIFI6 ready

2022 SRM935

- QCM6490
- SUB6G+SA/NSA
- 8-Cores 2.7Ghz
- L1+L5 GPS
- WIFI6

2021 SLM757

- MSM8917
- 4-Cores 1.4Ghz
- 41mm*41mm
- WIFI 2.4G/5G

2021 SLM759

- SDM450
- 8-Cores 1.8Ghz
- 44mm*43mm
- WIFI 2.4G/5G

2021 SLM500Q

- QCM2150
- 4-Cores 1.3Ghz
- 40.5mm*40.5mm
- WIFI 2.4G/5G

2021 SLM550

- QCM2290
- 4-Cores 2.0Ghz
- 40.5mm*40.5mm
- WIFI 2.4G/5G

2021 SRM900L

- SM4350
- SUB6G+SA/NSA
- 8-Cores 2.0Ghz
- L1+L5 GPS
- WIFI6 ready

2022 SLM550S

- UNISOC 8581
- 8-Cores 1.6Ghz
- 40.5mm*40.5mm
- WIFI 2.4G

2021 SLM755L

- MSM8909
- 4-Cores 1.1Ghz
- 40.5mm*40.5mm
- WIFI 2.4G

2021 SLM756

- MSM8909
- 4-Cores 1.1Ghz
- 39mm*44mm
- WIFI 2.4G/5G

2021 SLM500S

- UNISOC 8541E
- 4-Cores 1.4Ghz
- 40.5mm*40.5mm
- WIFI 2.4G

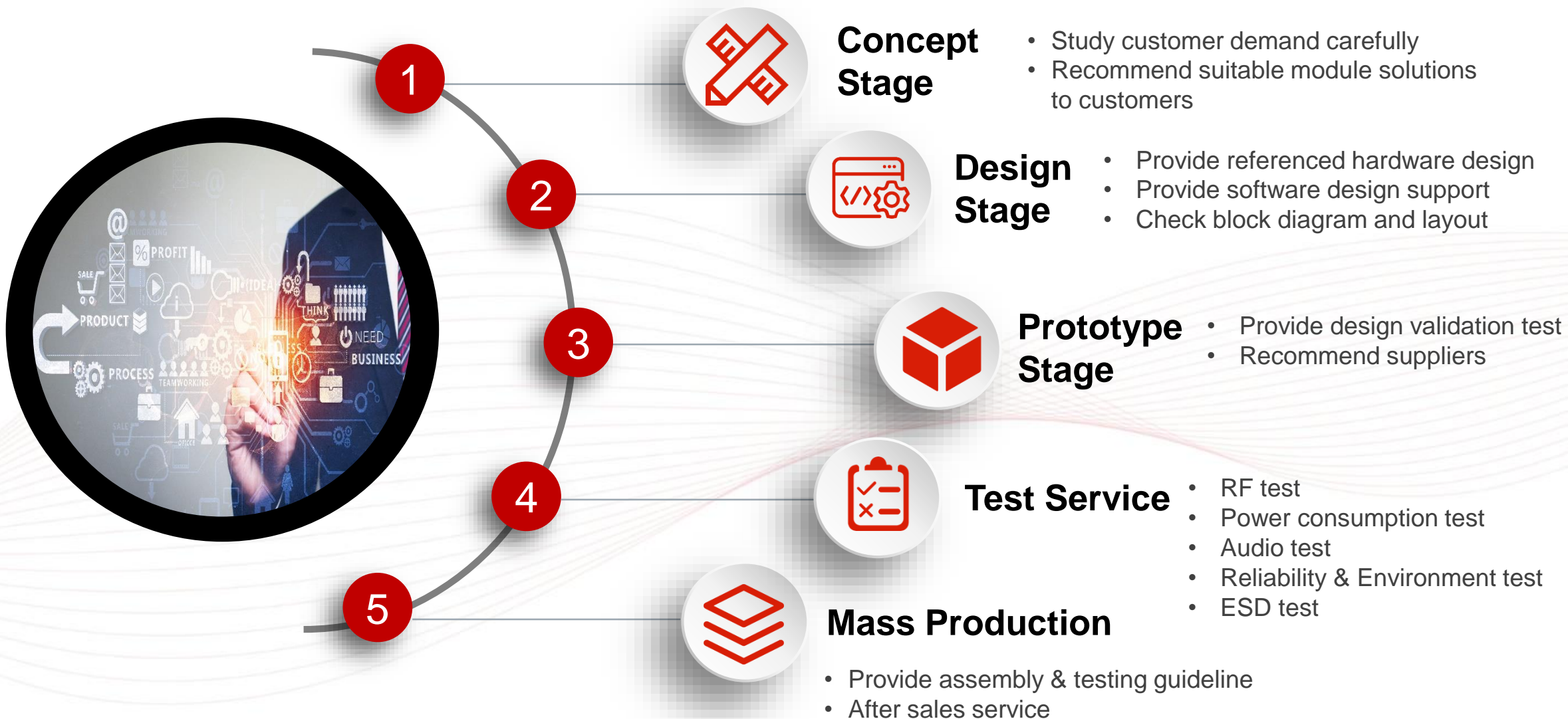


Before 2020

2021

2022

Customized Service

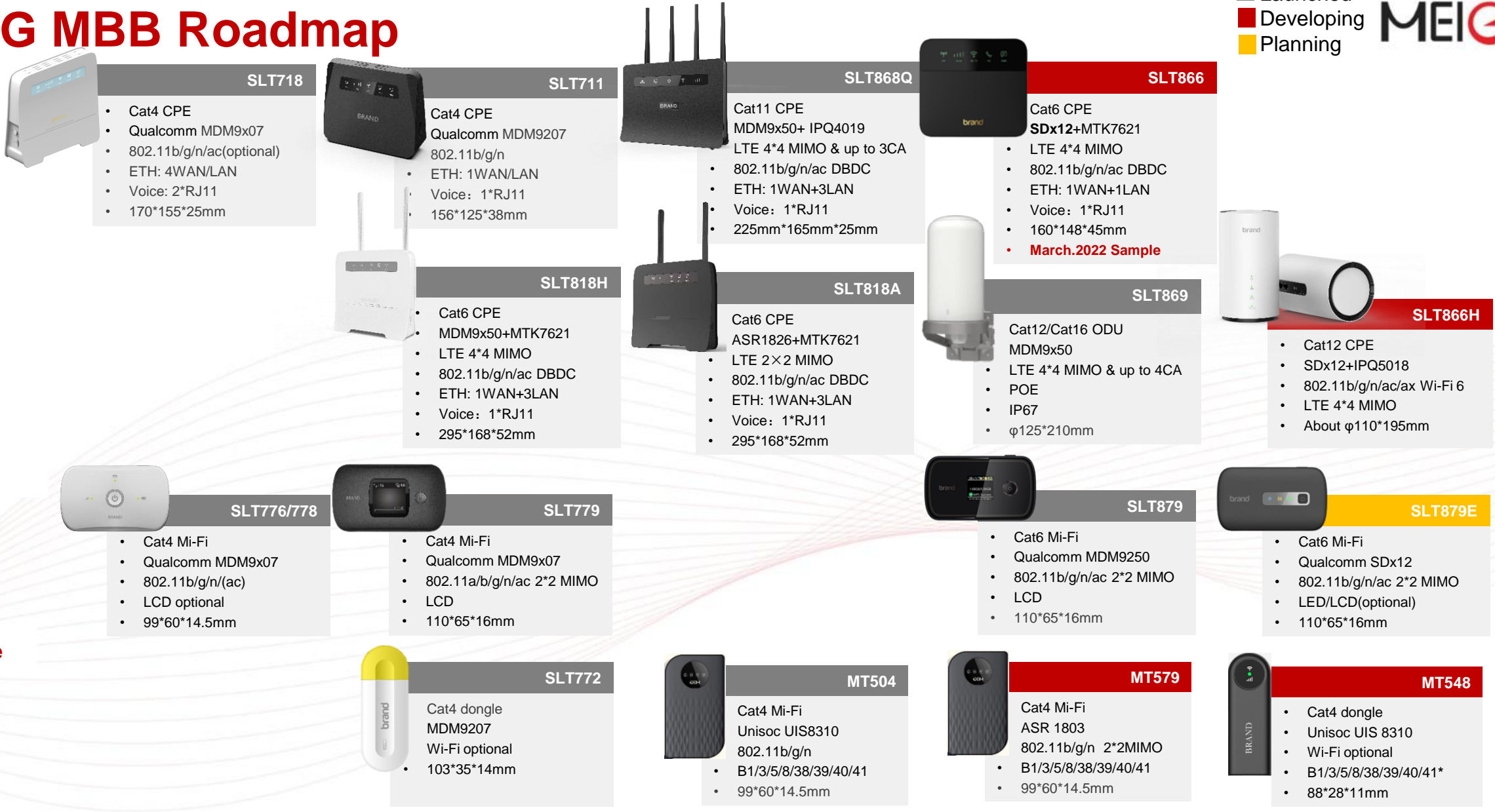


4G MBB Roadmap

CPE

MiFi

Dongle



Before 2020
2021
2022
2023

5G MBB Roadmap



- Launched
- Developing
- Planning

CPE IDU

MiFi/Dongle

CPE ODU

 <p>SRT838S</p> <ul style="list-style-type: none"> 5G CPE Qualcomm SDx55 R1 Sub6, SA&NSA, 4*4 MIMO 802.11a/b/g/n/ac/ax WiFi6 Low cost About 160*72*53mm 	 <p>SRT858</p> <ul style="list-style-type: none"> 5G CPE SDX62 Sub6, SA&NSA, 4*4 MIMO 802.11b/g/n/ac/ax, Wi-Fi 6 ETH: 1G*2 About 217.6*φ112mm 	 <p>SRT838iPro</p> <ul style="list-style-type: none"> 5G CPE Qualcomm SDx62 R16 Sub6, SA&NSA, 4*4 MIMO 802.11a/b/g/n/ac/ax WiFi6 Low cost About 160*72*53mm 	 <p>SRT838C</p> <ul style="list-style-type: none"> 5G CPE Unisoc V510 Sub6, SA&NSA, 4*4 MIMO 802.11a/b/g/n/ac/ax About 160*72*53mm 2023 Q2 	 <p>SRT858H</p> <ul style="list-style-type: none"> 5G CPE SDx62-1-AA-IPQ5018 Sub6, SA&NSA, 4*4 MIMO 802.11a/b/g/n/ac/ax About 217.6*φ112mm 2023 Q2 	 <p>SRT858M</p> <ul style="list-style-type: none"> 5G CPE Qualcomm SDx72-1 DL 4x4 MIMO 802.11a/b/g/n/ac/ax/ae AX5800 About 217.6*φ112mm 2023 Q4 	 <p>SRT835</p> <ul style="list-style-type: none"> 5G CPE Qualcomm SDx35 R17 DL 2x2 MIMO 36802.11a/b/g/n/ac About 120*74*18mm 2023 Q4
 <p>SRT873H/HS</p> <ul style="list-style-type: none"> 5G Mi-Fi Qualcomm SDx55 802.11b/g/n/ac/ax 2*2 MIMO LCD 5000mA Battery 130*70*19.5mm 	 <p>SRT875H</p> <ul style="list-style-type: none"> 5G Mi-Fi Qualcomm SDx62 R16 NR(DL/UL)3.16Gbps/550Mbps 802.11b/g/n/ac/ax 2*2 MIMO LCD About 133.5*71*17mm 	 <p>SRT875A</p> <ul style="list-style-type: none"> 5G Mi-Fi Qualcomm SDx65 R16 NR(DL/UL)4.8Gbps/900Mbps 802.11b/g/n/ac/ax 2*2 MIMO AX3600 LCD About 133.5*71*17mm 	 <p>SRT876(EU)</p> <ul style="list-style-type: none"> 5G Mi-Fi V510 + UWE5623DU 802.11 a/b/g/n/ac 2*2 MIMO DBSC LED 3600mA Battery 130*70*19.5mm 	 <p>SRB876CB</p> <ul style="list-style-type: none"> 5G Mi-Fi 公版 V510 + UWE5623DU 802.11 a/b/g/n/ac 2*2 MIMO DBSC LED 	 <p>SRT878H</p> <ul style="list-style-type: none"> 5G Mi-Fi Qualcomm SDx72 5G NR Sub-6GHz 802.11b/g/n/ac/ax 2*2 MIMO 5000mA Battery About 140*74*18mm Q1.2024 	
 <p>SRT853A</p> <ul style="list-style-type: none"> 5G ODU Qualcomm SDx62 R16 Sub6 SA&NSA 2.5G Ethernet POE IP65 186*111*35mm 	 <p>SRT853M</p> <ul style="list-style-type: none"> Qualcomm SDx62 R16 Sub-6&mmWave DL 4.3Gbps/2.3Gbps 186*111*35mm 2.5G Ethernet POE, IP65 QTM547*1 sup Parabolic Antenna 	 <p>SRT853L</p> <ul style="list-style-type: none"> SDx65 R16 Sub6 & mmWave DL 10Gbps/3.38Gbps 10G Ethernet POE IP65 QTM547*2 186*111*35mm sup Parabolic Antenna 	 <p>SRT853P</p> <ul style="list-style-type: none"> Parabolic Antenna Φ 198mm Fre:24.25-29.5GHz Beam Width: 2~2.5° Polarization: Dual-polarized Gain: 30dBi 			

2021 → 2022 → 2023 → 2024

ODM Products Portfolios

5G

Middle

Low


5G VideoCamera

- 5G SM6350
- Android 11
- LCD : 2.4 inch
- 64GB+4GB



5G PDA

- 5G SM6350
- Android 11
- LCD : 6 inch
- 64GB+4GB



5G PDA

- 5G QCM4490
- Android 13
- LCD: 6.0 inch
- 64GB+4GB




5G PDA

- 5G QCM6490
- Android 13
- LCD: 6.0 inch
- 128GB+8GB




4G PDA

- SM6115
- Android 11
- LCD : 5.5 inch
- 64GB+4GB



4G PAD

- Oct-Cores
- Android 11
- 8' 1440x720
- 32GB+3GB



4G 10' PAD

- SDM660
- Android 12
- 10' 2160x1080
- 64GB+4GB



4G 7' PAD

- SDM660
- Android 12
- 7' 2160x1080
- 64GB+4GB



MPOS

- UIS8310
- CAT1
- LCD: 2.5 inch
- 4Gb+1Gb




4G POS

- CM2150
- Android 9
- LCD: 4 inch
- 8GB+1GB



4G POS

- UIS8581
- Android 11
- LCD: 6.0 inch
- 16GB+2GB



4G POS

- QCM2290
- Android 11 Go
- 5" HD
- 1GB+8GB



20~21

2022

2023



Mobile Computer Solution



- 4G PAD**
- SDM660
 - Android 11
 - 10' 2160x1080
 - 64GB+4GB
 - WIFI 2X2

- 4G PAD**
- SM6115
 - Android 12
 - 10' 2160x1080
 - 64GB+6GB
 - WIFI ax-ready

- 5G-PAD**
- 5G SM4350Pro
 - Android 12
 - LCD: 10 inch
 - 128GB+6GB
 - WIFI ax-ready

- 5G-PAD**
- 5G QCM6490
 - Android 13-16
 - LCD: 10 inch
 - 128GB+8GB
 - WIFI6/6E



- 4G PDA**
- SM6115
 - Android 12
 - 5.5' 1440x720
 - 64GB+4GB Discrete
 - WIFI ax-ready

- 4G PDA**
- QCM4290
 - Android 12-14
 - 5.5' 1440x720
 - 64GB+4GB
 - WIFI6

- 5G PDA**
- 5G SM6350
 - Android 11
 - LCD: 6.0 inch FHD
 - 64GB+4GB
 - WIFI ax-ready

- 5G PDA**
- 5G QCM6490
 - Android 12-15
 - LCD: 6.0 inch FHD
 - 128GB+6GB
 - WIFI6/6E

- 5G PDA**
- 5G QCM4490
 - Android 13-17
 - LCD: 6.0 inch HD+
 - 64GB+4GB
 - WIFI6/6E

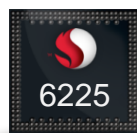
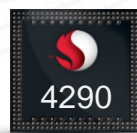
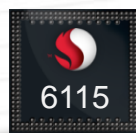


- 4G Keyboard**
- SDM660
 - Android 12
 - 4' FHD
 - 64GB+4GB
 - WIFI 2X2

- 4G Keyboard**
- SM6115
 - Android 12-14
 - 3.5' HD
 - 64GB+4GB
 - WIFI ax-ready

- 4G Keyboard**
- QCM4290
 - Android 12-14
 - 4.0' HD
 - 64GB+6GB
 - WIFI6

- 5G Keyboard**
- QCS6490
 - Android 14/15
 - 4.3' WVGA
 - 64GB+4GB
 - WIFI ax



Smart POS Solution



ECR Solution



Dual Display



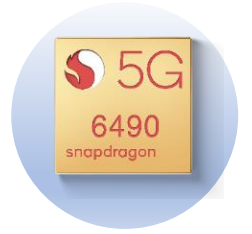
Face Recognition



Advanced Performance



Flagship



PCBA/Module Solution

